

R143-EG0 (rev. AAC2)

Rack Server - AMD EPYC™ 8004 - 1U UP 1 x PCIe Gen5 GPU (NVMe/SATA/SAS)

AI # AI Inference # Visual Computing # Networking # Hybrid/Private Cloud Server

Supports 1 x Dual slot Gen5 GPU Single AMD EPYC™ 8004 Series Processors

6-Channel RDIMM DDR5, 12 x DIMMs

Dual ROM Architecture

4 x 3.5"/2.5" Gen4 NVMe/SATA/SAS hot-swappable bays

1 x M.2 slot with PCIe Gen3 x4 interface

1 x FHFL PCIe Gen5 x16 slot for GPUs

1 x FHFL PCle Gen5 x16 slot

1 x FHHL PCIe Gen5 x16 slot

1 x OCP 3.0 Gen5 x16 slot





OVERVIEW **SPECIFICATIONS** SUPPORT **RESOURCES** Where to Buy

Dimensions (WxHxD. mm)

438 x 43.5 x 815

Motherboard

MEG3-GU0

CPU

AMD EPYC™ 8004 Series Processors Single processor, 5nm technology Up to 64 cores, 128 threads cTDP up to 225W

1 x LGA 4844 Socket SP6

Chipset

System on Chip

Memory

12 x DIMM slots DDR5 memory supported only 6-Channel memory architecture RDIMM up to 96GB supported Memory speed: Up to 4800 MT/s (1DPC), 3600 MT/s (2DPC)

Rear side: 1 x 10/100/1000 Mbps Management LAN

Integrated in Aspeed AST2600
2D Video Graphic Adapter with PCIe bus interface 1920x1200@60Hz 32bpp

Storage

Front side:

4 x 3.5"/2.5" Gen4 NVMe/SATA/SAS* hot-swappable bays

*SAS card is required to support SAS drives.

SAS

Require SAS add-in cards

RAID

Require RAID add-in cards

Expansion Slots

PCIe Cable x 3: - 1 x PCIe x16 (Gen5 x16) FHFL slot, for GPUs

- 1 x PCle x16 (Gen5 x16) FHFL slot, occupied when Dual slot GPU is installed

1 x OCP 3.0 slot with PCIe Gen5 x16 bandwidth Supports NCSI function

- 1 v M 2 slot

- M-key PCle Gen3 x4 Supports 2280/22110 cards

Internal I/O

1 x TPM header

Front I/O

2 x USB 3.2 Gen1

1 x Power button with LED 1 x ID button with LED

- 1 x NMI button 1 x Reset button
- 2 x LAN activity LEDs (disabled)
- 1 x Storage activity LED 1 x System status LED

Rear I/O

- 2 x USB 3.2 Gen1

- 1 x Mini-DP 1 x MLAN 1 x ID button with LED

Backplane Board

Speed and bandwidth:

PCIe Gen4 x4 or SATA 6Gb/s or SAS 12Gb/s

1 x TPM header with SPI interface

Optional TPM2.0 kit: CTM010

1+1 1300W 80 PLUS Platinum redundant power supplies

100-240V~/ 12-7A 50-60Hz

- 200-240V~/ 8A, 50-60Hz

DC Input: (Only for China) - 240Vdc/ 6.5A

DC Output:

- Max 1000W/ 100-240V~ +12V/ 80.5A

- +12Vsb/3A
- Max 1300W/ 200-240V~ or 240Vdc Input
- +12V/ 105.4A +12Vsb/ 3A

System Management

Aspeed AST2600 management controller GIGABYTE Management Console (AMI MegaRAC SP-X) web interface

Dashboard
HTML5 KVM
Sensor Monitor (Voltage, RPM,
Temperature, CPU Staftus ...etc.)
Sensor Reading History Data
FRU Information
SEL Log in Linear Storage / Circular
Storage Policy
Hardware Inventory
Fan Profile
System Firewall
Power Consumption
Power Consumption
Power Control
Advanced power capping
LDAP / AD / RADIUS Support
Backup & Restore Configuration
Remote BIOS/BMC/CPLD Update
Event Log Filter
User Management
Media Redirection Settings
SAL Settings
SMLTS Settings
SMTS Settings
SMTS Settings SSL Settings SMTP Settings

OS Compatibility

Please refer to OS compatibility table in support page

System Fans

8 x 40x40x56mm (29,700rpm)

Operating Properties

Operating temperature: 10°C to 35°C
Operating humidity: 8%-80% (non-condensing)
Non-operating temperature: -40°C to 60°C
Non-operating humidity: 20%-95% (non-condensing)

Packaging Dimensions

1038 x 588 x 238 mm

Packaging Content

- 1 x R143-EG0-AAC2
- 1 x CPU heatsink 1 x Mini-DP to D-Sub cable
- 1 x GPU power cable (12VHPWR to 12VHPWR, 450mm) 1 x 2-Section Rail kit

Part Numbers

- Barebne package: 6NR143EGDR000AAC2*
 Motherboard: 9MEG3GU0UR-000
 2-Section Rail kit (CMA not supported): 25HB2-3A0206-K0R
 CPU heatsink: 25ST1-44320G-A0R
 M.2 heatsink: 125P2-1100DE-00R
 Front board CFP1010: 9CFP1010NR-00
 Backplane board CFP1047: 9CBP1047NR-00
 Fan module: 25ST2-405623-A0R
 I/O board CBG70: 9CBG70NR-00
 Mini-DP to D-Sub cable: 25CRN-200801-K1R
 GPU power cable (12VHPWR, 450mm): 25CRI-450101-Y4R
 Power supply: 25EP0-21300B-F3S

Optional parts:

- 3-Section Rail kit (Supports CMA): 25HB2-A56121-K0R Cable Management Arm: 25HB1-R18300-K0R
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- * Advertised performance is based on maximum theoretical interface values from respective Chipset vendors or organization who defined the interface specification. Actual performance may vary by system configuration.
- * All trademarks and logos are the properties of their respective holders.
- * Due to standard PC architecture, a certain amount of memory is reserved for system usage and therefore the actual memory size is less than the stated amount.